

LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver

Check for Samples: [LMH0001](#)

FEATURES

- SMPTE 259M and SMPTE 344M Compliant
- Data Rates to 540 Mbps
- Supports DVB-ASI at 270 Mbps
- Differential Input
- 75Ω Differential Output
- Adjustable Output Amplitude
- Single 3.3V Supply Operation
- Industrial Temperature Range: -40°C to +85°C
- 125mW Typical Power Consumption
- 16-pin WQFN Package
- Footprint Compatible with the LMH0002SQ and the GS9078A.

APPLICATIONS

- SMPTE 259M and SMPTE 344M Serial Digital Interfaces
- DVB-ASI Applications
- Sonet/SDH and ATM Interfaces
- Digital Routers and Switches
- Distribution Amplifiers
- Buffer Applications
- Set Top Boxes
- Security Cameras

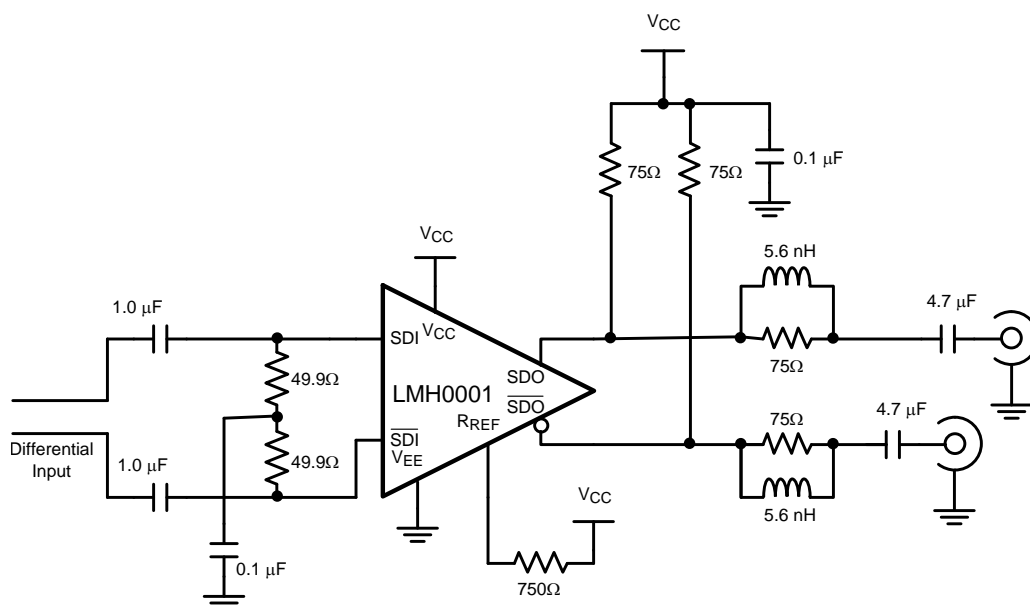
DESCRIPTION

The LMH0001 SMPTE 259M / 344M Serial Digital Cable Driver is designed for use in SMPTE 259M / 344M serial digital video applications. The LMH0001 drives 75Ω transmission lines (Belden 8281, Belden 1694A or equivalent) at data rates up to 540 Mbps.

The output voltage swing of the LMH0001 is adjustable via a single external resistor.

The LMH0001 is powered from a single 3.3V supply. Power consumption is typically 125mW. The LMH0001 is available in a 16-pin WQFN package.

Typical Application



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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

Absolute Maximum Ratings ⁽¹⁾

Supply Voltage:	-0.5V to 3.6V
Input Voltage (all inputs)	-0.3V to $V_{CC}+0.3V$
Output Current	28mA
Storage Temperature Range	-65°C to +150°C
Junction Temperature	+150°C
Lead Temperature (Soldering 4 Sec)	+260°C
Package Thermal Resistance θ_{JA} 16-pin WQFN θ_{JC} 16-pin WQFN	+78.9°C/W +42.7°C/W
ESD Rating (HBM)	5kV
ESD Rating (MM)	250V

- (1) "Absolute Maximum Ratings" are those parameter values beyond which the life and operation of the device cannot be guaranteed. The stating herein of these maximums shall not be construed to imply that the device can or should be operated at or beyond these values. The table of "Electrical Characteristics" specifies acceptable device operating conditions.

Recommended Operating Conditions

Supply Voltage ($V_{CC} - V_{EE}$):	3.3V $\pm 5\%$
Operating Free Air Temperature (T_A)	-40°C to +85°C

DC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified ⁽¹⁾⁽²⁾.

Parameter		Test Conditions	Reference	Min	Typ	Max	Unit
V_{CMIN}	Input Common Mode Voltage		SDI, \overline{SDI}	1.6 + $V_{SDI}/2$		$V_{CC} -$ $V_{SDI}/2$	V
V_{SDI}	Input Voltage Swing	Differential		100		2000	mV _{P-P}
V_{CMOUT}	Output Common Mode Voltage		SDO, \overline{SDO}		$V_{CC} -$ V_{SDO}		V
V_{SDO}	Output Voltage Swing	Single-ended, 75 Ω load, $R_{REF} = 750\Omega$ 1%		750	800	850	mV _{P-P}
		Single-ended, 75 Ω load, $R_{REF} = 590\Omega$ 1%		900	1000	1100	mV _{P-P}
I_{CC}	Supply Current				⁽³⁾ 38	43	mA

- (1) Current flow into device pins is defined as positive. Current flow out of device pins is defined as negative. All voltages are stated referenced to $V_{EE} = 0$ Volts.
 (2) Typical values are stated for $V_{CC} = +3.3V$ and $T_A = +25^\circ C$.
 (3) Maximum I_{CC} is measured at $V_{CC} = +3.465V$ and $T_A = +70^\circ C$.

AC Electrical Characteristics

Over Supply Voltage and Operating Temperature ranges, unless otherwise specified ⁽¹⁾.

Parameter	Test Conditions	Reference	Min	Typ	Max	Unit
DR _{SDI}	Input Data Rate	⁽²⁾ SDI, $\overline{\text{SDI}}$			540	Mbps
t _{jit}	Additive Jitter	270 Mbps		18		pSP,p
t _r , t _f	Output Rise Time, Fall Time	20% – 80%	400	560	800	ps
	Mismatch in Rise/Fall Time	⁽²⁾			30	ps
	Duty Cycle Distortion	⁽²⁾			100	ps
t _{OS}	Output Overshoot	⁽²⁾			8	%
RL _{SDO}	Output Return Loss		⁽³⁾ 15	20		dB

- (1) Typical values are stated for V_{CC} = +3.3V and T_A = +25°C.
- (2) Specification is guaranteed by characterization.
- (3) Output return loss is dependent on board design. The LMH0001 meets this specification on the SD001SQ evaluation board from 5MHz to 1.5GHz.

CONNECTION DIAGRAM

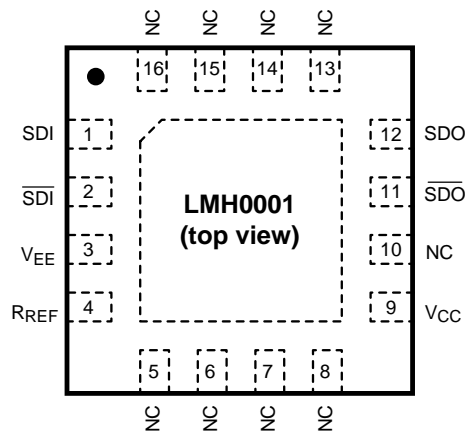


Figure 1. 16-Pin WQFN Package
See Package Number RUM0016A

PIN DESCRIPTIONS

SOIC Pin No.	WQFN Pin No.	Name	Description
1	1	SDI	Serial data true input.
2	2	$\overline{\text{SDI}}$	Serial data complement input.
3	3	V _{EE}	Negative power supply (ground).
4	4	R _{REF}	Output driver level control. Connect a resistor to V _{CC} to set output voltage swing.
5	9	V _{CC}	Positive power supply (+3.3V).
7	11	$\overline{\text{SDO}}$	Serial data complement output.
8	12	SDO	Serial data true output.
—	5, 6, 7, 8, 10, 13, 14, 15, 16	NC	No connect.
—	DAP	V _{EE}	Connect exposed DAP to negative power supply (ground).

DEVICE OPERATION

INPUT INTERFACING

The LMH0001 accepts either differential or single-ended input. The inputs are self-biased, allowing for simple AC or DC coupling. DC-coupled inputs must be kept within the specified common-mode range. $\overline{\text{SDI}}$ and $\overline{\text{SDI}}$ are self-biased at approximately 2.1V with $V_{CC} = 3.3\text{V}$. Figure 2 shows the differential input stage for $\overline{\text{SDI}}$ and $\overline{\text{SDI}}$.

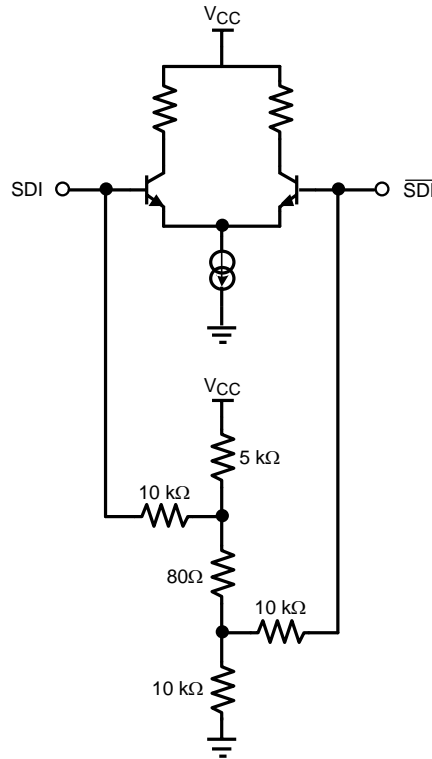





Figure 2. Differential Input Stage for $\overline{\text{SDI}}$ and $\overline{\text{SDI}}$.

OUTPUT INTERFACING

The LMH0001 uses current mode outputs. Single-ended output levels are 800 mV_{P-P} into 75Ω AC-coupled coaxial cable (with $R_{REF} = 750\Omega$). Output level is controlled by the value of the R_{REF} resistor connected between the R_{REF} pin and V_{CC} .

The R_{REF} resistor should be placed as close as possible to the R_{REF} pin. In addition, the copper in the plane layers below the R_{REF} network should be removed to minimize parasitic capacitance.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
LMH0001SQ/NOPB	ACTIVE	WQFN	RUM	16	1000	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	L001	
LMH0001SQE/NOPB	ACTIVE	WQFN	RUM	16	250	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	L001	
LMH0001SQX/NOPB	ACTIVE	WQFN	RUM	16	4500	Green (RoHS & no Sb/Br)	CU SN	Level-1-260C-UNLIM	-40 to 85	L001	

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

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Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Only one of markings shown within the brackets will appear on the physical device.

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TAPE AND REEL INFORMATION

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE


*All dimensions are nominal

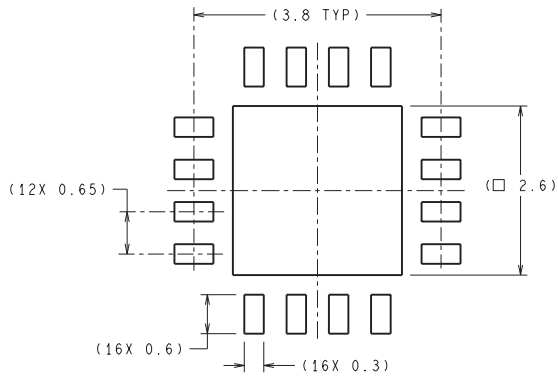
Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMH0001SQ/NOPB	WQFN	RUM	16	1000	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LMH0001SQE/NOPB	WQFN	RUM	16	250	178.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1
LMH0001SQX/NOPB	WQFN	RUM	16	4500	330.0	12.4	4.3	4.3	1.3	8.0	12.0	Q1

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

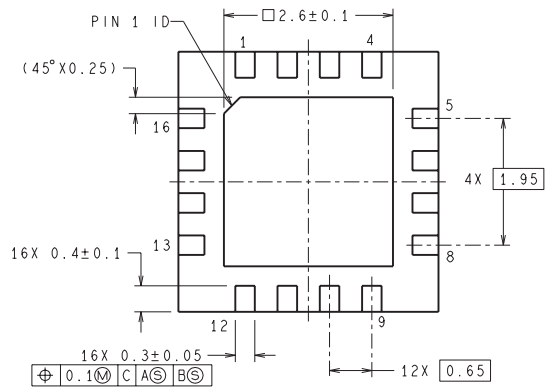
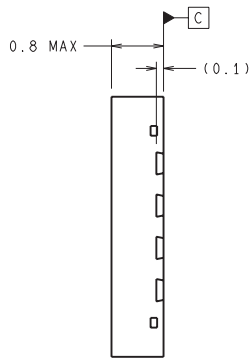
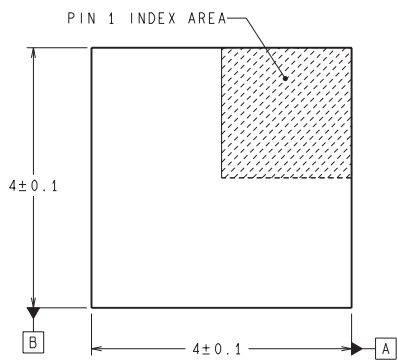
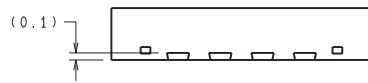
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMH0001SQ/NOPB	WQFN	RUM	16	1000	210.0	185.0	35.0
LMH0001SQE/NOPB	WQFN	RUM	16	250	210.0	185.0	35.0
LMH0001SQX/NOPB	WQFN	RUM	16	4500	367.0	367.0	35.0

RUM0016A



RECOMMENDED LAND PATTERN

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SQB16A (Rev A)

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